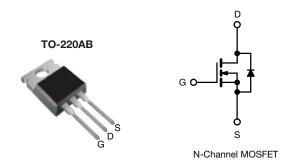


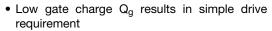


## **Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V	3.0			
Q <sub>g</sub> (Max.) (nC)	17				
Q <sub>gs</sub> (nC)	4.3				
Q <sub>gd</sub> (nC)	8.5				
Configuration	Single				

### **FEATURES**





- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective C<sub>oss</sub> specified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- · High speed power switching

### **TYPICAL SMPS TOPOLOGIES**

- · Two transistor forward
- Half bridge
- Full bridge

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF820APbF
Lead (Pb)-free and halogen-free	IRF820APbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	500	V	
Gate-source voltage			$V_{GS}$	± 30		
Continuous drain current	V at 10 V	$T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 100  ^{\circ}\text{C}$		2.5		
	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	1.6	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	10	]	
Linear derating factor				0.40	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	140	mJ	
Repetitive avalanche current a			I <sub>AR</sub>	2.5	А	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	5.0	mJ	
Maximum power dissipation	T <sub>C</sub> =	25 °C	$P_{D}$	50	W	
Peak diode recovery dV/dt c			dV/dt	3.4	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) d	For 10 s 300 <sup>c</sup>		300 <sup>d</sup>			
Mounting torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Starting  $T_J$  = 25 °C, L = 45 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 2.5 A (see fig. 12)
- c.  $I_{SD} \le 2.5 \text{ A}$ ,  $dI/dt \le 270 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150 \,^{\circ}\text{C}$
- d. 1.6 mm from case



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# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	2.5	

SPECIFICATIONS (T <sub>J</sub> = 25 °C, t	ınless otherw	ise noted)					
PARAMETER	SYMBOL	TEST	TEST CONDITIONS			MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.60	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4.5	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>G</sub>	V <sub>GS</sub> = ± 30 V		-	± 100	nA
Zana ala albana dari anna d		V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V		-	-	25	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.5 A <sup>b</sup>	-	-	3.0	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 1.5 A <sup>b</sup>		1.4	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V}, \\ V_{DS} = 25 \text{ V}, \\ f = 1.0 \text{ MHz, see fig. 5}$ $V_{GS} = 0 \text{ V}; V_{DS} = 1.0 \text{ V}, f = 1.0 \text{ MHz}$ $V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}, f = 1.0 \text{ MHz}$ $V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ V to } 400 \text{ V}^c$		-	340	-	pF
Output capacitance	C <sub>oss</sub>			-	53	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	2.7	-	
Output capacitance	C <sub>oss</sub>				490		
Output capacitance	C <sub>oss</sub>				15		
Effective output capacitance	C <sub>oss</sub> eff.				28		
Total gate charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 2.5 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	17	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	4.3	
Gate-drain charge	$Q_{gd}$	see lig. 0 and 13		-	-	8.5	-
Turn-on delay time	t <sub>d(on)</sub>	,		-	8.1	-	
Rise time	t <sub>r</sub>	V <sub>22</sub> - 2!	50 V In = 2.5 Δ	-	12	-	1
Turn-Off delay time	t <sub>d(off)</sub>	$V_{DD} = 250 \text{ V, } I_{D} = 2.5 \text{ A,}$ $R_{g} = 21 \Omega, R_{D} = 97 \Omega, \text{ see fig. } 10^{b}$		-	16	-	ns
Fall time	t <sub>f</sub>			-	13	-	
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.5	А
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	10	
Body diode voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 2.5  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	1.6	V
Body diode reverse recovery time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 2.5 A, dl/dt = 100 A/μs <sup>b</sup>		-	330	500	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	760	1140	nC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub>			y L <sub>S</sub> and	L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

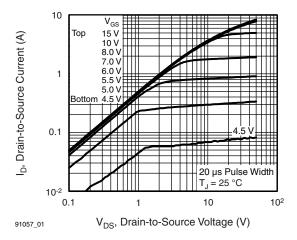


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

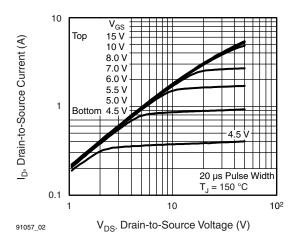


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C

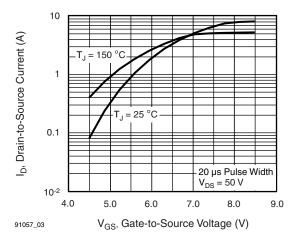


Fig. 3 - Typical Transfer Characteristics

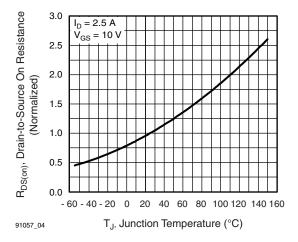


Fig. 4 - Normalized On-Resistance vs. Temperature

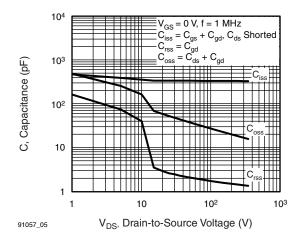


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

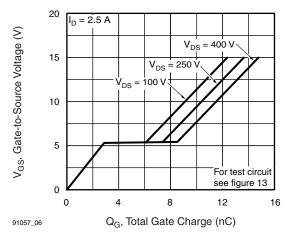


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



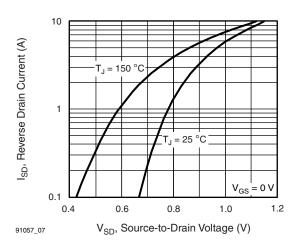


Fig. 7 - Typical Source-Drain Diode Forward Voltage

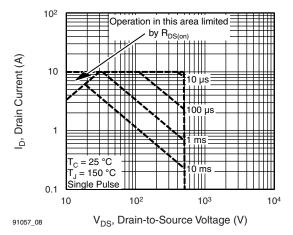


Fig. 8 - Maximum Safe Operating Area

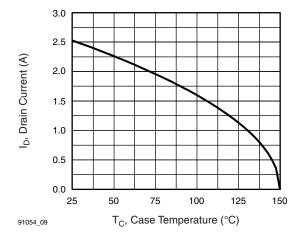


Fig. 9 - Maximum Drain Current vs. Case Temperature

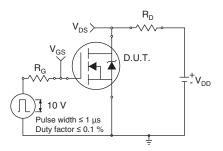


Fig. 10 - Switching Time Test Circuit

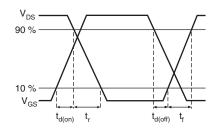


Fig. 11 - Switching Time Waveforms



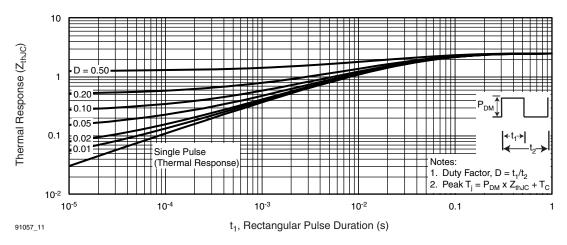


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

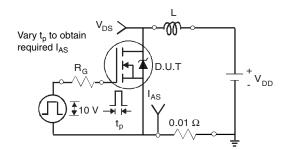


Fig. 13 - Unclamped Inductive Test Circuit

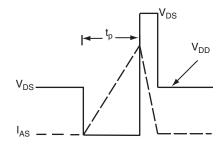


Fig. 14 - Unclamped Inductive Waveforms

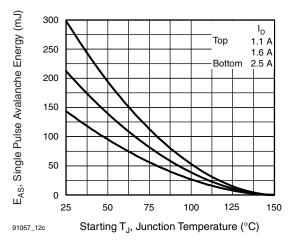


Fig. 15 - Maximum Avalanche Energy vs. Drain Current

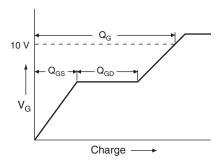


Fig. 16 - Basic Gate Charge Waveform



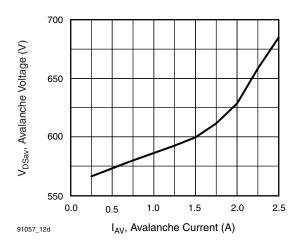


Fig. 17 - Typical Drain-to-Source Voltage vs. Avalanche Current

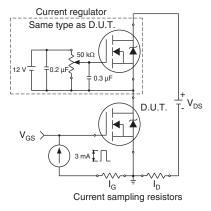
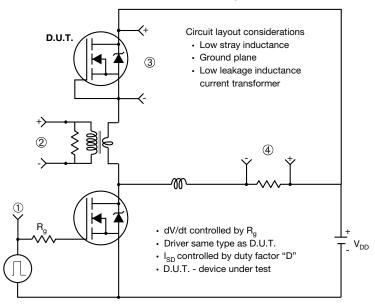


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



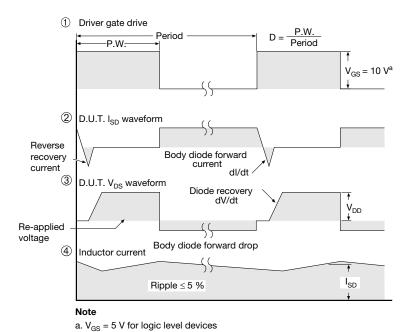


Fig. 19 - For N-Channel

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